

## Trench MOS Barrier Schottky Rectifier

### TSP5S150B

#### SMB



Cathode  Anode

### Features

- Advanced trench technology
- Low forward voltage drop
- Low power losses
- High efficiency operation
- Lead Free Finish, RoHS Compliant

### Applications

- DC/DC Converters
- AC/DC Adaptors
- Switching Power Supplies
- Freewheeling Diodes

### Maximum ratings and electrical characteristics (T<sub>J</sub> = 25°C unless otherwise noted)

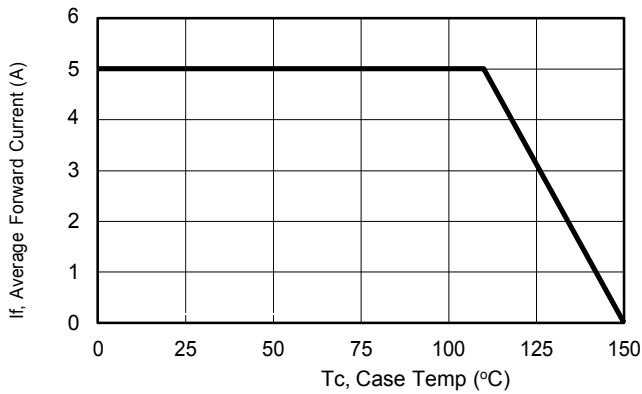
Parameter		Symbol	Limit		Unit	
Maximum repetitive peak reverse voltage		VRRM	150		V	
Maximum average forward rectified current		IF(AV)	5		A	
Peak forward surge current 8.3 ms single half sine- wave superimposed on rated load per diode		IFSM	120		A	
Operating junction and storage temperature range		TJ, TSTG	-50 to +150		°C	
Typical thermal resistance per diode(Mounted on FR-4 PCB)		RθJC	22		°C/W	
Instantaneous forward voltage per diode		VF(1)	TYP.	MAX.	V	
	IF=1A		TJ=25°C	0.53		0.60
	IF=1A		TJ=125°C	0.48		-
	IF=5A		TJ=25°C	0.89		0.95
	IF=5A		TJ=125°C	0.82		-
Instantaneous reverse current per diode at rated reverse voltage	TJ=25°C	IR(2)	5	10	uA	
	TJ=125°C		5	-	mA	

Notes:

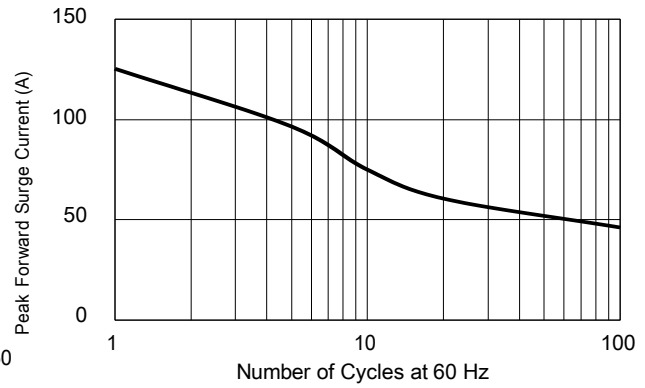
(1) Pulse test: 300 μs pulse width, 1 % duty cycle

(2) Pulse test: Pulse width ≦ 40 ms

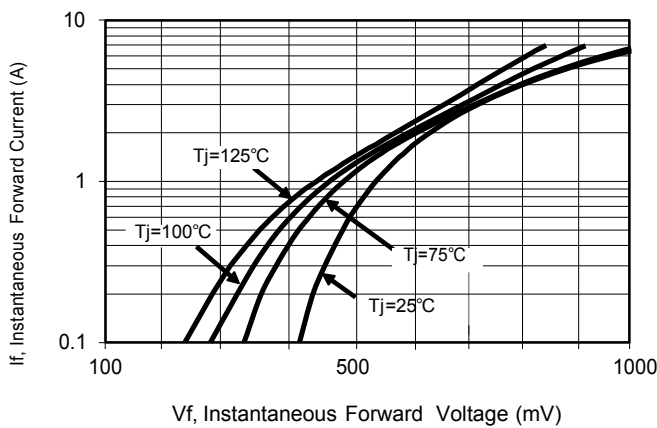
## RATINGS AND CHARACTERISTICS CURVES (TA = 25 °C unless otherwise noted)



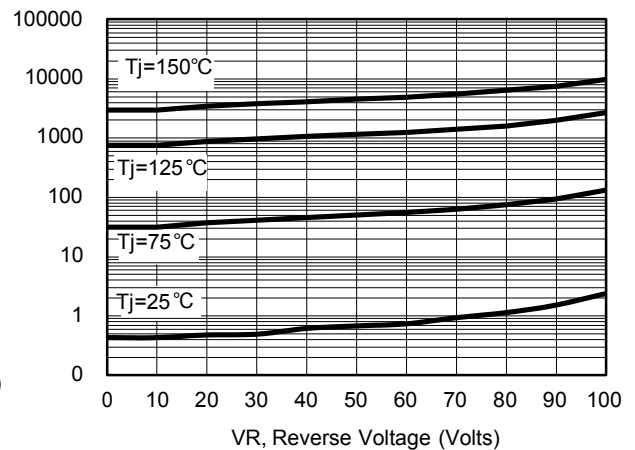
**Current Derating, Case**



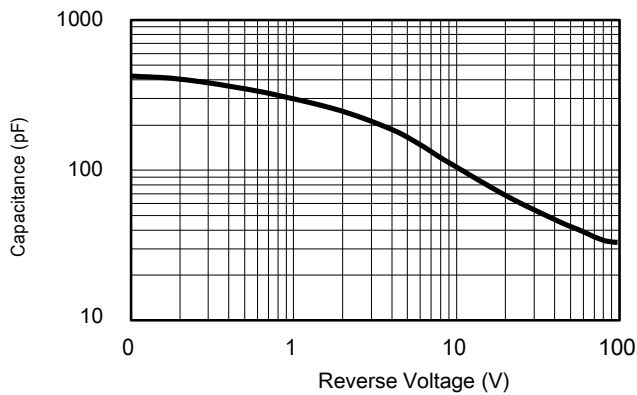
**Maximum Repetitive Surge Current**



**Typical Forward Voltage**



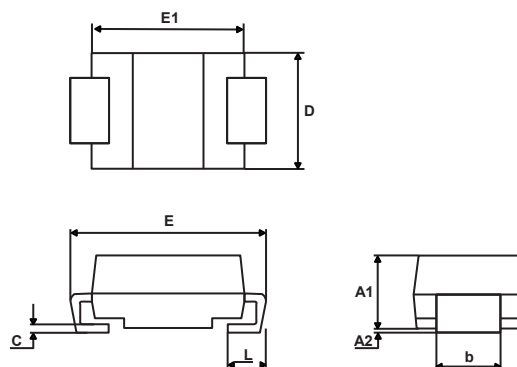
**Typical Reverse Current**



**Typical Junction Capacitance**

## PACKAGE OUTLINE DIMENSIONS

### SMB dimension definitions



### SMB dimension values

Ref.	Dimensions			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A1	1.90	2.45	0.075	0.096
A2	0.05	0.20	0.002	0.008
b	1.95	2.20	0.077	0.087
c	0.15	0.40	0.006	0.016
D	3.30	3.95	0.130	0.156
E	5.10	5.60	0.201	0.220
E1	4.05	4.60	0.159	0.181
L	0.75	1.50	0.030	0.059